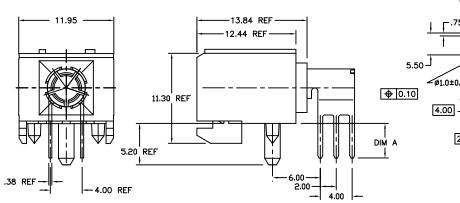


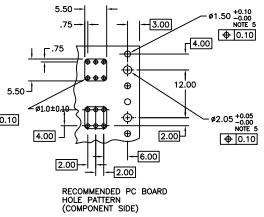
FCIconnect.com

3 |

PCB THICKNESS	DIM A
2.4	3.5
1.6	2.7
2.4	3.5
1.6	2.7
	THICKNESS 2.4 1.6 2.4



- 9.50 -



- BODY MATERIAL: LCP, 30% GLASS-FILLED, FLAME RETARDENT, ACC, UL94-V0
- 2. TERMINAL MATERIAL: BeCu
- 3. PLATING SOLDER TAILS: FOR 70424-0XX SnPb FOR 70424-0XXLF Sn (LEAD FREE)
- 4. PLATING CONTACT AREA: 0.80µm Au OVER 1.3µm Ni.
- 5. INDICATED HOLES ARE UNPLATED
- 6. PRODUCT MARKETING: PART NUMBER & BATCH I.D.
- 7. THE PRODUCTS WHERE THE PART NUMBER ENDS IN "LF" MEET THE EUROPEAN DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
- 8. ALL PRODUCTS WILL WITHSTAND EXPOSURE TO 260° FOR 60 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.

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						ASME Y14.5 V ASME Y14.5							Þ)-∈	1	METRAL (tm)								
ltr	r ecn no dr date					tolerances unless otherwise specified						7	<u> </u>	コ	title								
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В	V617	725	SAR	1996	-11-18	anyu	·] [2																
С	V812	212	MDF	1998-06-17		o. Ŧ	2			±.051		scal	e 1	:1	W/ METRAL HSG 7029						92	2	
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PDM: Rev:F

STATUS: Released Printed: Nov 29, 2007

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